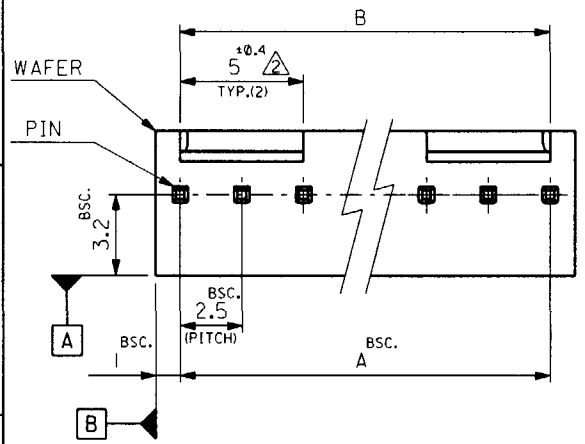
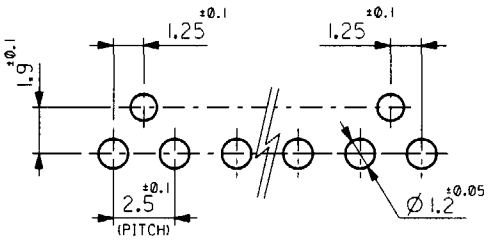
ENG. NO SD-5045-NA5
EDP NO. 39-31-4••4

:MM DIMENSIONS IN METRIC DO NOT SCALE DRAWING



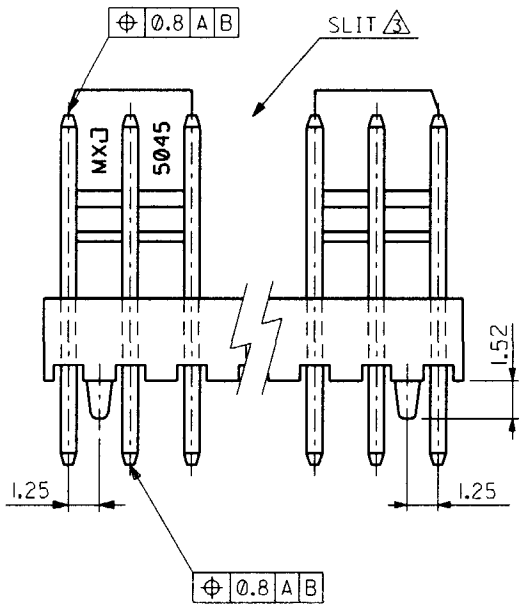


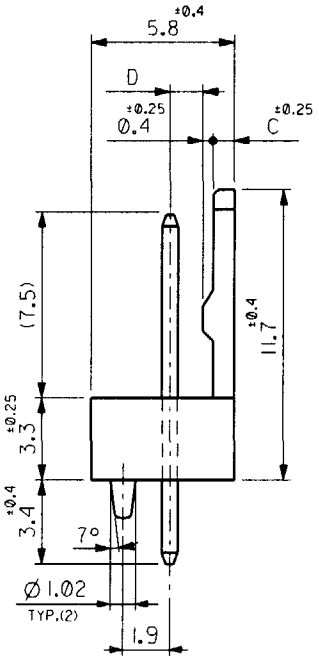
(NON ACCUMULATIVE)

RECOMMENDED P.C. BOARD HOLE DIM.

NOTES

1. MATERIAL
   WAFER : 66NYLON UL94V-0
   PIN : □0.635 BRASS, TIN OVER COPPER PLATING
2. TO BE APPLIED FOR 6CKT. AND MORE THAN 6CKT.
3. NO SLIT IS PROVIDED FOR 5CKT. AND LESS THAN 5CKT.





D	C	B	A	EDP NO.	ENG. NO.	CKT.
1.35	Ø0.85	37.5 +0.3 -0.45	37.5	39-31-4164	5045-16A5	16
↑	↑	35 +0.3 -0.45	35	-4154	-15A5	15
		32.5 +0.25 -0.45	32.5	-4144	-14A5	14
		30 +0.25 -0.4	30	-4134	-13A5	13
		27.5 +0.25 -0.4	27.5	-4124	-12A5	12
		25 +0.2 -0.4	25	-4114	-11A5	11
		22.5 +0.2 -0.4	22.5	-4104	-10A5	10
		20 +0.15 -0.35	20	-4094	-09A5	9
		17.5 +0.15 -0.35	17.5	-4084	-08A5	8
		15 +0.1 -0.3	15	-4074	-07A5	7
		12.5 +0.1 -0.3	12.5	-4064	-06A5	6
		10 +0.15 -0.3	10	-4054	-05A5	5
1.35	Ø0.85	7.5 +0.15 -0.3	7.5	-4044	-04A5	4
1.2	1	5 +0.15 -0.3	5	-4034	-03A5	3
1.2	1	2.5 +0.15 -0.3	2.5	39-31-4024	-02A5	2

LTR	記号	REVISION RECORD 変更内容	DR. CHK.	DATE 日付
B		REVISED (J00976)	K.T H.H	'90/9/11
A		REVISED (J00686)	K.T Y.Y	'90/6/2
0		RELEASED (J00486)	K.T Y.Y	'90/4/26

角度 ANGLE	±3°
30以上 OVER	±0.3
10以上 30未満 OVER UNDER	±0.25
10未満 UNDER	±0.2
一般公差 GENERAL TOLERANCES	

REVISE ONLY ON CAD SYSTEM

材料 MATERIAL: SEE NOTES
仕上げ FINISH
適用電線範囲 WIRE RANGE
被覆外径 INS. RANGE

DRAWN BY K.TOJO '90/4/26
CHK'D BY '90/05/13 M.FUKUSHIMA
APP'D BY '90/05/13 M.ENOMOTO
尺度 SCALE 5 - 1

MOLEX-JAPAN CO.,LTD. 日本モレックス株式会社

EDP. NO. 39-31-4••4
ENG. NO. SD-5045-NA5 REV B
TITLE 名称 KK 2.5 WAFER ASS'Y WITH LOCK

5045.S10 A

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